

## **EXPEDITED PROCEDURE - EXAMINING GROUP 2835**

**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: George Hsieh Examiner: Gregory Thompson

Serial No.:

09/897320

Group Art Unit: 2835

Filed:

June 29, 2001

Docket No.: 884.462US1

Title:

ELECTRONIC ASSEMBLY WITH SOLDERABLE HEAT SINK AND

METHODS OF MANUFACTURE

Assignee: **Intel Corporation**  Customer No.: 21186

## AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In response to the Final Office Action mailed January 20, 2004, please amend the application as set forth below.

This response is accompanied by a Request for Continuing Examination, as well as the appropriate fee, and a Petition, as well as the appropriate fee, to obtain a one month extension of the period for responding to the Office action, thereby moving the deadline for response from April 20, 2004 to May 20, 2004.